



SOLDER COATING

Type ISO 9454 / 1-1.1.2. A

General Data

SOLDER COATING is a resin based Flux with a low halogen content according to ISO 9454 / 1-1.1.2. A.

SOLDER COATING possesses very good activating properties for the wetting surfaces of the soldering partners. The specific activation of the flux expands the usability of the flux over a wide temperature range.

SOLDER COATING Was developed specifically as a secondary flux for use as a dip-flux, for repairs, for wire tip tinning and other comparable uses. When applied, it guarantees a complete coating and thus an optimal protection against oxidation.

SOLDER COATING is also suitable as coating for pre-forms and bare metal surfaces. The residues are dry, malleable and transparent.

Physical Data

Color	: amber
Flash point	: 13°C
Density 20°C	: 0.820 g/cm ³
Solids content	: 5.0%
Acid value	: 28±2
Flux type	: ISO 9454 / 1-1.1.2.A; RE L1

If condensation can occur during application, appropriate moisture protection measures must be implemented.

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